

HSMC-C400

Side-Fire Mono-Color Surface-Mount ChipLED

Description

The Broadcom® HSMC-C400 is a side-emitting surface-mount chipLED. This chipLED is available in industrial popular package footprint of 3.2 mm × 2.55 mm. This product comes with integrated optical lens that narrows the viewing angle of the light beam, thereby increasing the on-axis intensity. This allows effective light coupling into secondary optics, such as a light guide and a light pipe.

It offers industry-leading performance by using efficient and high-brightness AlInGaP LED materials.

This chipLED is ideal for applications that require narrow beam angle or high on-axis intensity. Examples include industrial equipment, consumer electronics, and black-and-white home appliances. It is compatible with industry-standard automatic machine placement and reflow soldering.

Features

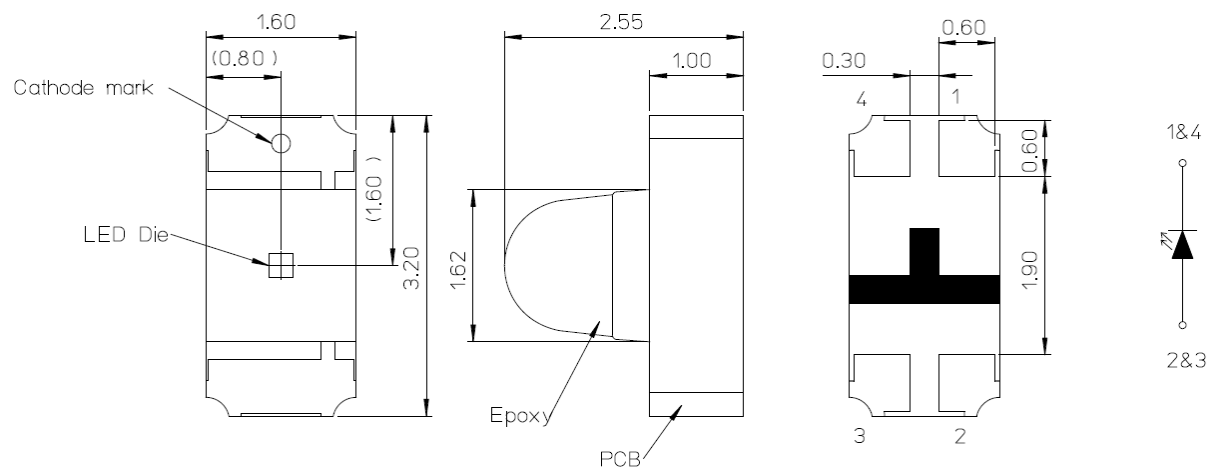
- LED with AlInGaP Red
- Compatible with reflow soldering
- Available in 8-mm tape on 7-in. diameter reels

Applications

- Backlighting
- Status indicator

CAUTION! LEDs are class 1A ESD sensitive per ANSI/ESDA/JEDEC JS-001. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

Figure 1: Package Dimensions



- NOTE:**
- 1. All dimensions are in millimeters.
 - 2. Tolerance ± 0.1 mm unless otherwise specified.
 - 3. Dimensions in brackets are for reference only.

Absolute Maximum Value at $T_J = 25^{\circ}\text{C}$

Parameter	Rating	Units
DC Forward Current ^a	25	mA
Power Dissipation	60	mW
LED Junction Temperature	95	$^{\circ}\text{C}$
Operating Temperature Range	-40 to $+85$	$^{\circ}\text{C}$
Storage Temperature Range	-40 to $+85$	$^{\circ}\text{C}$

a. Derate as shown in [Figure 5](#).

Electrical Characteristics at $T_J = 25^{\circ}\text{C}$

Color	Forward Voltage V_F (Volts) ^a @ $I_F = 20$ mA		Reverse Current I_R (μA) ^b @ $V_R = 5$ V	Thermal Resistance, $R\theta_{J-S}$ ($^{\circ}\text{C}/\text{W}$) ^c
	Min.	Max.	Max.	Typ.
Red	1.6	2.4	100	500

- a. V_F tolerance: ± 0.1 V.
- b. Indicates product final test condition only. Long-term reverse bias is not recommended.
- c. Thermal resistance from LED junction to solder point.

Optical Characteristics at $T_J = 25^\circ\text{C}$

Color	Luminous Intensity I_V^a (mcd) @ 20mA		Peak Wavelength λ_{peak} (nm)	Dominant Wavelength λ_d^b (nm)	Viewing Angle $2\theta_{1/2}^c$ (Degrees)
	Min.	Max.	Typ.	Typ.	Typ.
Red	28.5	450.0	633	623	90

- a. The luminous intensity is measured at the mechanical axis of the LED package. The actual peak of the spatial radiation pattern may not be aligned with the axis.
- b. The dominant wavelength, λ_d , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
- c. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is $\frac{1}{2}$ the peak intensity.

Bin Information

Intensity Bins (CAT)

Bin ID	Luminous Intensity (mcd)	
	Min.	Max.
N	28.5	45.0
P	45.0	71.5
Q	71.5	112.5
R	112.5	180.0
S	180.0	285.0
T	285.0	450.0

Tolerance $\pm 15\%$.

Example of bin information on reel and packaging label:

CAT: x —> Red Iv bin

BIN: x —> Red color bin

Color Bins (BIN)

Bin ID	Dominant Wavelength (nm)	
	Min.	Max.
—	620	635

Tolerance ± 1 nm.

Figure 2: Relative Intensity vs. Wavelength

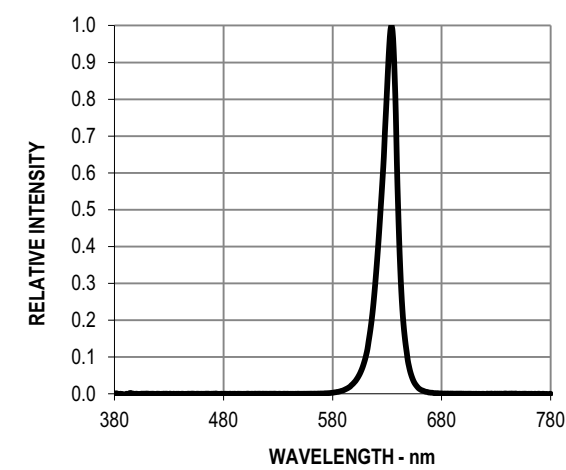


Figure 3: Forward Current vs. Forward Voltage

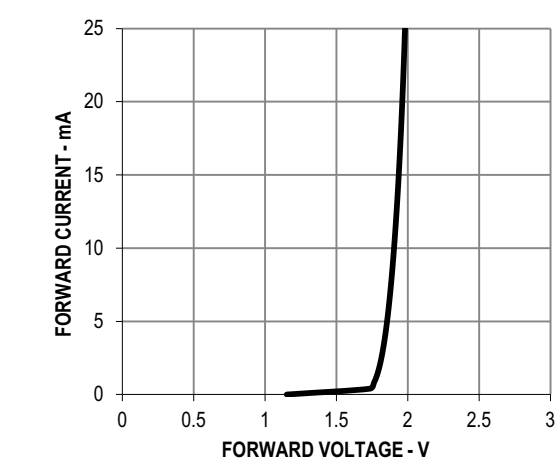


Figure 4: Luminous Intensity vs. Forward Current

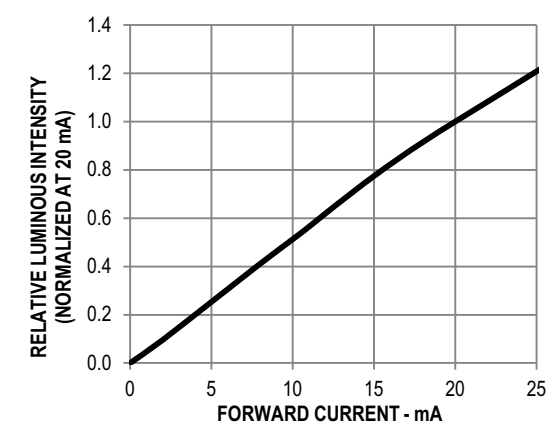


Figure 5: Maximum Forward Current vs. Ambient Temperature

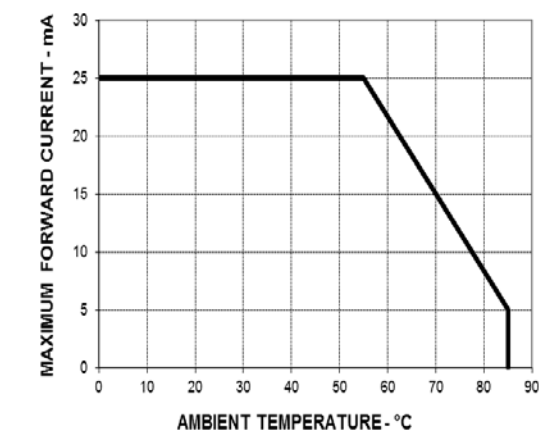


Figure 6: Relative Intensity vs. Angle

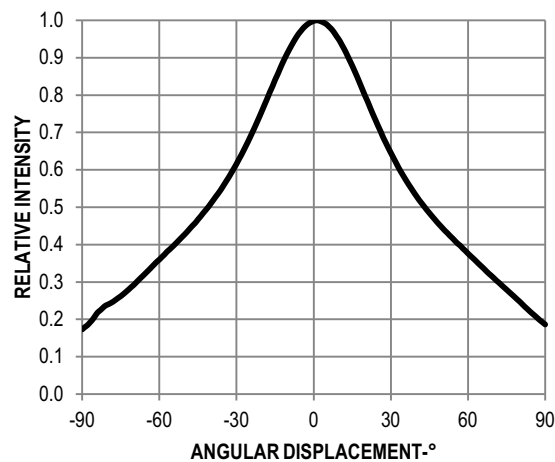


Figure 7: Recommended Soldering Land Pattern (Units: mm)

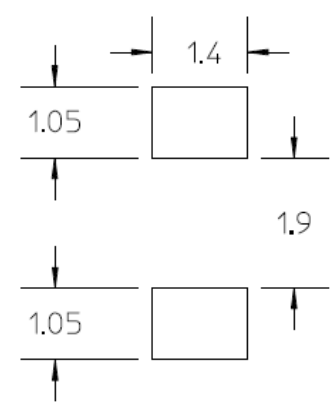


Figure 8: Reel Dimensions

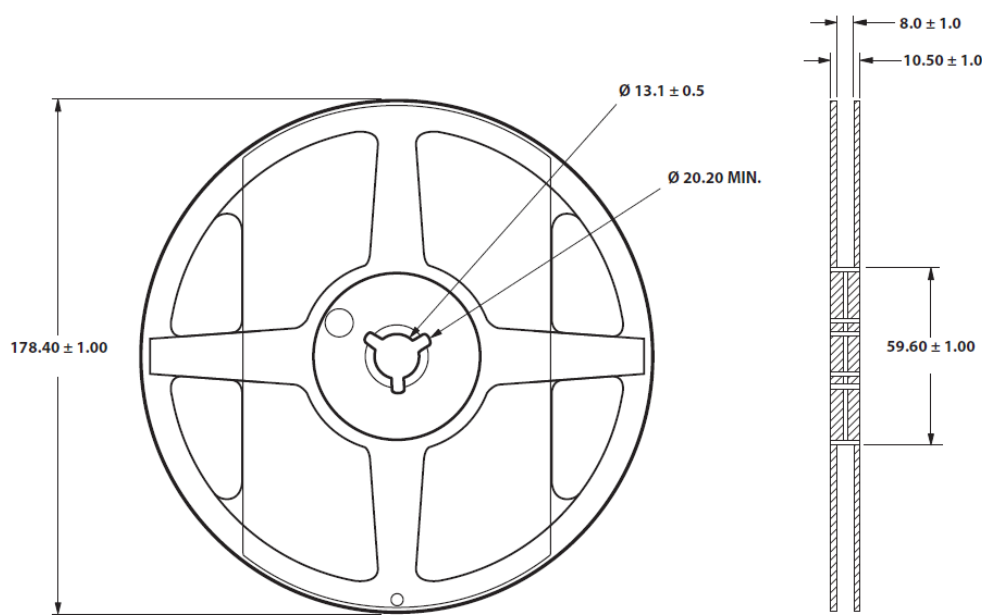
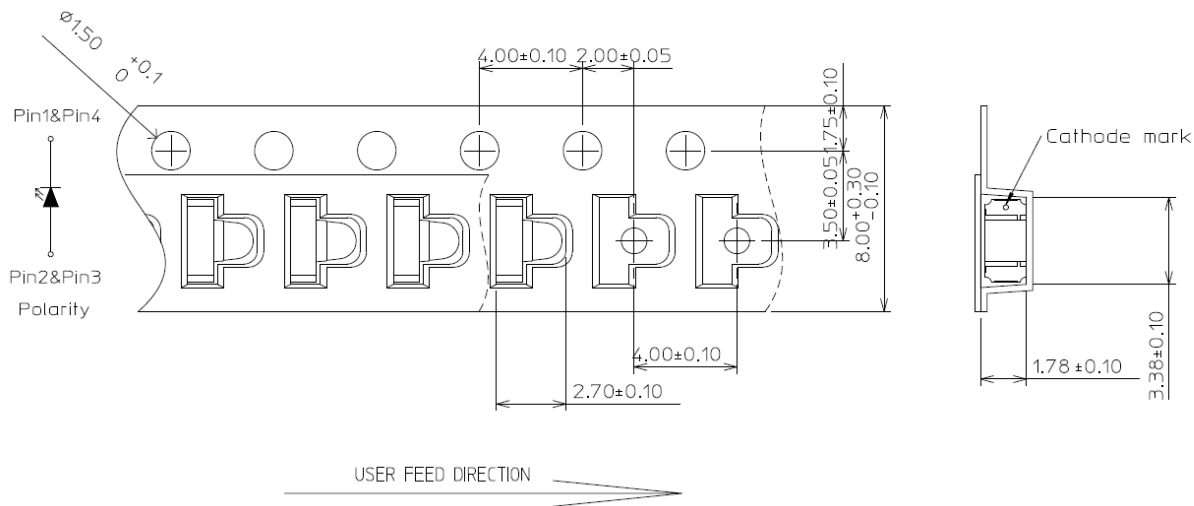
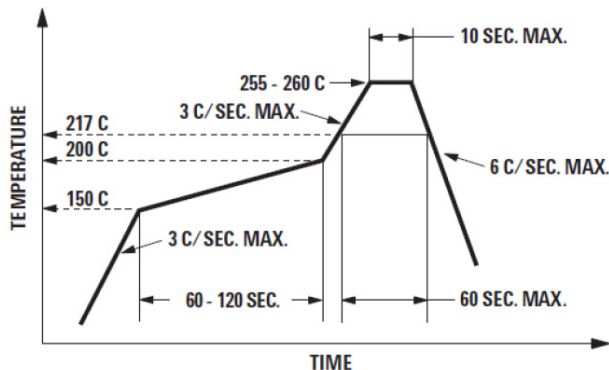


Figure 9: Tape Dimensions (Units: mm)

Soldering

Figure 10: Recommended Reflow Soldering Conditions

- Reflow soldering must not be done more than twice. Observe necessary precautions of handling moisture sensitive device as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- Use reflow soldering to solder the LED. If unavoidable (such as rework), use manual hand soldering strictly controlled to the following conditions:
 - Soldering iron tip temperature = 310°C maximum
 - Soldering duration = 2 seconds maximum
 - Number of cycles = 1 only
 - Power of soldering iron = 50W maximum
- Do not touch the LED package body with the soldering iron except for the soldering terminals because it might cause damage to the LED.

- Confirm beforehand whether the functionality and performance of the LED is affected by hand soldering.

Precautionary Notes

Handling of a Moisture-Sensitive Device

This product has a Moisture Sensitive Level 2a rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices*, for additional details and a review of proper handling procedures.

- **Before use:**
 - An unopened moisture barrier bag (MBB) can be stored at < 40°C/90% RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity indicator card (HIC) indicates that baking is not required, it is safe to reflow the LEDs per the original MSL rating.
 - Do not open the MBB prior to assembly (for example, for IQC).
- **Control after opening the MBB:**
 - Read the HIC immediately upon opening the MBB.
 - Keep the LEDs at < 30°C/60% RH at all times, and all high-temperature-related processes, including soldering, curing, or rework, must be completed within 672 hours.

■ Control for unfinished reel:

Store unused LEDs in a sealed MBB with desiccant or desiccator at < 5% RH.

■ Control of assembled boards:

If the PCB soldered with the LEDs is to be subjected to other high-temperature processes, store the PCB in a sealed MBB with desiccant or desiccator at < 5% RH to ensure that all LEDs have not exceeded their floor life of 672 hours.

■ Baking is required if the following conditions exist:

- The HIC indicator indicates a change in color for 10% and 5% as stated on the HIC.
- The LEDs are exposed to conditions of > 30°C/60% RH at any time.
- The LEDs' floor life exceeded 672 hours.

The recommended baking condition is: 60°C ±5°C for 20 hours.

Baking should only be done once.

Eye Safety and Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs as it may be harmful to the eyes. For safety reasons, use appropriate shielding or personnel protection equipment.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- LEDs exhibit slightly different characteristics at different drive currents that might result in larger performance variations (that is, intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- Avoid rapid change in ambient temperature, especially in high-humidity environments, because this will cause condensation on the LED.
- If the LED is intended to be used in harsh environments, protect the LED against damages caused by rain water, dust, oil, corrosive gases, external mechanical stress, and so on.

Disclaimer

Broadcom's products are not specifically designed, manufactured, or authorized for sale as parts, components, or assemblies for the planning, construction, maintenance, or direct operation of a nuclear facility or for use in medical devices or applications. The customer is solely responsible, and waives all rights to make claims against Broadcom or its suppliers, for all loss, damage, expense, or liability in connection with such use.

Broadcom, the pulse logo, Connecting everything, Avago Technologies, Avago, and the A logo are among the trademarks of Broadcom and/or its affiliates in the United States, certain other countries and/or the EU.

Copyright © 2016–2017 Broadcom. All Rights Reserved.

The term “Broadcom” refers to Broadcom Limited and/or its subsidiaries. For more information, please visit www.broadcom.com.

Broadcom reserves the right to make changes without further notice to any products or data herein to improve reliability, function, or design. Information furnished by Broadcom is believed to be accurate and reliable. However, Broadcom does not assume any liability arising out of the application or use of this information, nor the application or use of any product or circuit described herein, neither does it convey any license under its patent rights nor the rights of others.





**Стандарт
Электрон
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331